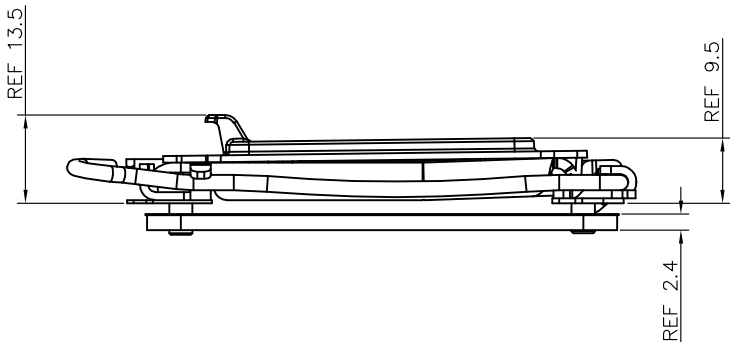
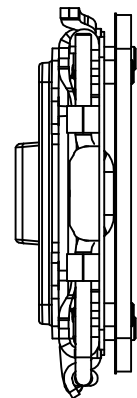
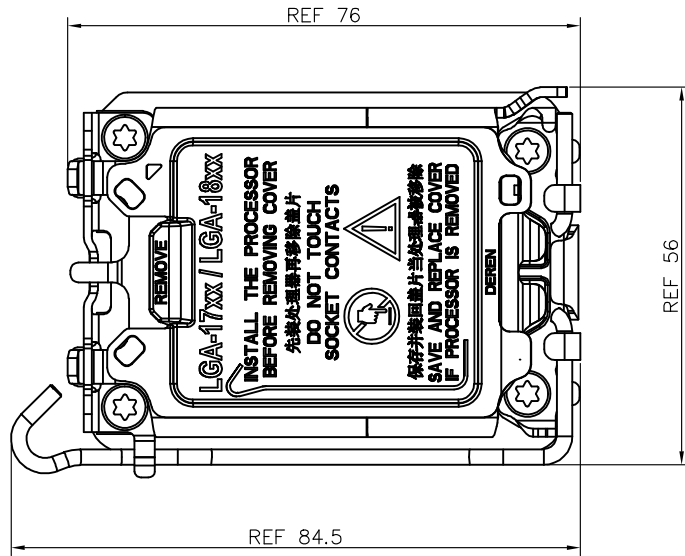



REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A			INITIAL RELEASE	2021.06.16	Justin



NOTES:

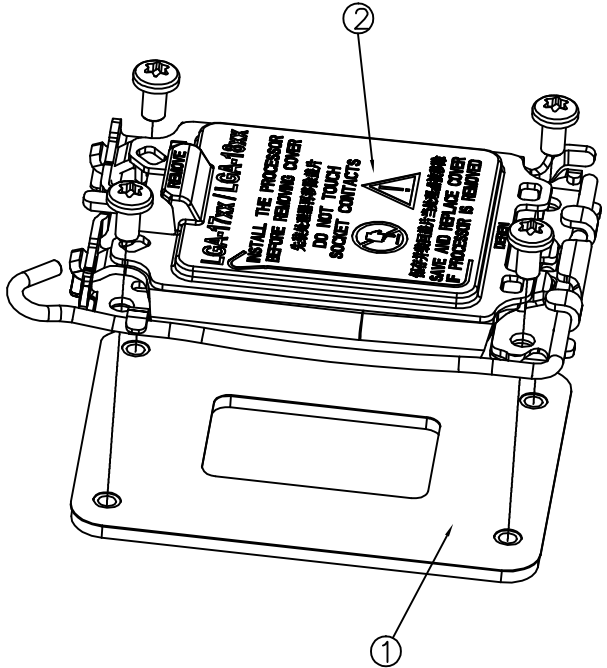
- PART NUMBER IS PARENT LINE ITEM NUMBER ON ENGINEERING BILL OF MATERIAL
- PARTS ARE TO BE CLEAN AND FREE FROM FOREIGN MATERIAL: DIRT, OIL, GREASE, OR ANY OTHER CONTAMINANTS.
- BREAK ALL SHARP CORNERS, EDGES, AND BURRS.
- ALL COMPONENTS SHOULD MEET INTEL'S ENVIRONMENTAL REQUIREMENTS.
- ALL DIMENSIONS AND MATERIALS CONTROLLED AT COMPONENT AND SUBASSEMBLY LEVELS.
- ALL PACKING SHALL PREVENT ANY DISLODGING OR DEFORMATION OF INSULATORS.

MOLD NUMBER				 <b>DEREN</b> SHENZHEN DEREN ELECTRONIC CO., LTD	CUSTOMER DRAWING		DATE	TITLE: Socket V ILM ASM					
DIM	TOL	DIM	TOL		DESIGN:	Justin	2020/02/12	P/N:	56ZZ05-004H				
X.	±0,30	X.	±0.1'	DRAW NO. SC2006537	CHECK:	Andy	2020/02/13	SHEET:	1/2				
.X	±0,25	.X	±0.5'		REV.	A	APPROVAL:	Smark	2020/02/15	SCALE:	1:1	UNIT:	mm
.XX	±0,15	.XX	±0.1'										

REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A			INITIAL RELEASE	2021.06.16	Justin

QTY	ITEM NO	DEREN PART NUMBER	DEREN DESCRIPTION	INTEL PART NUMBER	INTEL DESCRIPTION	
	1	2	560004-006H	SOCKET V ILM TOP SIDE ASSEMBLY	K95976-002	LGA 17XX, ILM TOP SIDE ASSEMBLY
	1	1	560004-008H	SOCKET V ILM BACK PLATE WITH SCREWS	K94071-001	LGA 17XX, ILM BACK PLATE WITH SCREWS
		TOP	56ZZ05-004H	SOCKET V ILM ASM	K62851-003	LGA 17XX, ILM TOP ASSEMBLY

PARTS LIST



MOLD NUMBER				DRAW NO.	DEREN			SHENZHEN DEREN ELECTRONIC CO., LTD	
DIM	TOL	DIM	TOL		CUSTOMER DRAWING	DATE	TITLE: Socket V ILM ASM		
.X	±0,30	.X	±0.1'	SC2006537	DESIGN:	Justin	2020/02/12	P/N: 56ZZ05-004H	
.X	±0,25	.X	±0.5'		CHECK:	Andy	2020/02/13	SHEET:	2/2
.XX	±0,15	.XX	±0.1'		REV. A	APPROVAL:	Smark	2020/02/15	SCALE:
								UNIT:	mm